Unaxis Shuttleline ICP RIE
Metal Etch Plasma Processing System
Users Manual

Coral name: Unaxis ICP Etcher
Model: Unaxis Shuttleline ICP/RIE
Location: Nanofab, Building 215
Contact: nanofab_dryetch@nist.gov
Revision: 1.0
Tool Description:

The ICP metal etch system is a Unaxis Shuttleline series system with a sample loadlock. The system has an Inductively Coupled Plasma (ICP) coil and a capacitively coupled substrate RF supply to independently control plasma density and ion energy in the system. This system is dedicated to the etching of Chromium, Aluminum, Titanium and other Chlorine-based etchable metals. The fixturing is configured for 3" and 4" diameter Si wafers and uses a clamp ring to hold the sample on the RF chuck.

Detailed Specifications:

- 2500 W ICP coil power at 2 MHz and 300 W substrate bias at 13.56MHz plasma generators.
- Cl₂, BCl₃, O₂, Ar, SF₆ gases available
- Helium back-side cooling.
- Windows-based computer control of process and wafer handling.

Safety Precautions:

- Use care when handling the wafer shuttle and ceramic holder, they are fragile and expensive. Handle with clean gloves only!
- The shuttle can be “HOT”. Remove with care.
- Do not force open the load lock, when in vacuum.
- Use gloves or tweezers when loading and unloading samples and wafer shuttles.

Starting the System

The system should be up and running. Do not attempt to shutdown or restart the system. Please contact the Nanofab staff if the tool is not operational.

Logging on the System

1. Click on the yellow-edged [Login here] in the Current User window in the control panel.
   a. The <<Log in/out>> window appears.
2. Enter the user name in the <<User Name>> field.
   a. The user name is <<2222>>.
   b. The pull-down menu can also be used to select the available user names. Select by clicking in the list.
3. Enter the password in the <<Password>> field.
   a. The password is <<2222>>.
4. Confirm password entry by clicking the [OK] button or by pressing the ENTER key.

Substrate Loading

Process as follows to load a substrate into the system:

1. Make sure the load lock is isolated from the reactor chamber.
   a. Refer to the <<Vacuum>> screen section of the Maintain menu if necessary.
2. Vent the lock.
   a. Refer to the <<Vacuum>> screen of the Maintain menu for the venting the lock procedure.
3. Place a substrate in the shuttle arm.
4. Pump the lock.
   a. Refer to the <<Vacuum>> screen

Software Preparations

This section describes the set up needed for getting the SLC software ready for process operations. It is important to address all of the following prior to activating a process from the software.

Control System

1. Make sure the SLC application is running.
2. Make sure an Operator is properly logged into the system.
3. Make sure there are no active alarms on the system. Address as needed.

Process Recipes

1. Make sure any needed recipes are created and saved on the system. This can be verified in the <<Run>> screen of the Jobs menu.
   a. If not, refer to the <<Recipe Editor>> screen in the Editors menu for creating and saving process recipe if necessary.
2. Verify that the recipe being used has the correct parameter settings for the process.

System Chambers
1. Verify that the software recognizes a loaded substrate on the shuttle arm. Also, verify that the software recognizes the reactor chamber as being empty.
   a. Refer to the <<Material ID>> fields in the Overview screen to confirm this.

2. Make sure that the system pumps are working and the system is capable of being pumped down.

Running a Process on the SHUTTLELINE

Verify the following before running a process on the SHUTTLELINE system.

- The system and all support components are powered.
- The SLC software is currently running.
- Required process recipes are created and saved on the system.
- Substrate is loaded into the lock. Reactor chamber is empty.
- System is cleared of active alarms.

NOTE: If any of the conditions above are not met, refer to the previous sections to ready the SHUTTLELINE for processing.

Loading a Recipe

1. Select a recipe from the recipe list and highlight the selected recipe.
   a. Refer to the <<Run>> screen in the Jobs menu.
2. Enter an ID for the substrate being processed in the <<Material ID>> field.
3. Click on the [Run] button to start the process recipe selected.
   a. Once processing of the substrate begins, details of the process recipe can be viewed in the upper right corner of the main screen panel <<Run>>

Monitoring Systems Parameters

Once Processing begins, the user can view different aspects of the system. The following table lists where to monitor specific system activity.

<table>
<thead>
<tr>
<th>Parameters</th>
<th>Screen</th>
<th>Menu</th>
</tr>
</thead>
<tbody>
<tr>
<td>Process Data (State, Recipe, Step, etc.)</td>
<td>Run</td>
<td>Jobs</td>
</tr>
<tr>
<td>Process Data, Chamber Data, Material Status (Recipe info, pressure, temp, etc.)</td>
<td>Overview</td>
<td>Systems</td>
</tr>
</tbody>
</table>
### Stopping a Process

Process recipes can be stopped in the `<Run>` screen of the Jobs menu.

1. Click on the [Stop] button to cease the process currently being executed.

### Substrate Unloading

Process as follows to unload a substrate from the system:

5. **Make sure the load lock is isolated from the reactor chamber.**
   a. Refer to the `<Vacuum>` screen section of the **Maintain** menu if necessary.

6. **Vent the lock.**
   a. Refer to the `<Vacuum>` screen of the **Maintain** menu for the venting the lock procedure.

**NOTE:** A recipe can be setup to automatically vent the lock after processing has been complete.

Place a substrate in the shuttle arm.

7. **Pump the lock.**
   a. Refer to the `<Vacuum>` screen

### Logging off the System

1. **Click on the yellow-edged [Login here] in the Current User window in the control panel.**
   a. The login/out window appears.

2. **Click on the [Log out] button to log off the system.**
Creating a Recipe

Proceed as follows to create a process recipe in the <<Recipe Editor>> screen:

1. **Click on the [New] button and enter a name for the new recipe.**
   a. The SLC software will default this field to “untitled”.

2. **Create the recipe by inserting, copying, or deleting steps in the <<Recipe Steps>> list.**
   a. Process
   b. Transfer
   c. Evac

3. **Set up the parameters in the step panel for each step. Apply ramping, compliance, and endpoint detection parameters if necessary.**

**Step Parameters**

<table>
<thead>
<tr>
<th>Step Type</th>
<th>Behavior/Function</th>
<th>Configurable Parameters</th>
</tr>
</thead>
<tbody>
<tr>
<td>INIT</td>
<td>Begins the process recipe by preparing the chambers temperature, pressure, and material status.</td>
<td>Material Handling, Pumping, Temperature</td>
</tr>
<tr>
<td>XFER</td>
<td>Calls for the system to transfer material in or out of the chamber.</td>
<td>None (Transfer Step Only)</td>
</tr>
<tr>
<td>EVAC</td>
<td>Programs the system to pump the chamber to a specified pressure.</td>
<td>Pumping</td>
</tr>
<tr>
<td>PROC</td>
<td>This step type performs the actual reaction on the substrate based on the process parameters and duration of its parameters.</td>
<td>Duration, Throttle Control, Backside Cooling, Gas, RF</td>
</tr>
<tr>
<td>END</td>
<td>Ends the process recipe by setting the chamber to a specified pressure and removing the material.</td>
<td>Pumping, Material Handling</td>
</tr>
</tbody>
</table>
### INIT Settings

<table>
<thead>
<tr>
<th>Panel</th>
<th>Parameter</th>
<th>Settings</th>
</tr>
</thead>
<tbody>
<tr>
<td>Material Handling</td>
<td>Transfer Material In</td>
<td>• Enabled&lt;br&gt;• Disabled</td>
</tr>
<tr>
<td>Pumping</td>
<td>Base Pressure</td>
<td>Setpoint (Torr)</td>
</tr>
<tr>
<td></td>
<td>Hold Time (step time)</td>
<td>(hr, min, sec)</td>
</tr>
<tr>
<td>Temperature</td>
<td>Heat Exchanger</td>
<td>Setpoint ($^\circ$ C)</td>
</tr>
</tbody>
</table>

### PROC Settings

<table>
<thead>
<tr>
<th>Panel</th>
<th>Parameter</th>
<th>Settings</th>
</tr>
</thead>
<tbody>
<tr>
<td>Duration</td>
<td>• Time</td>
<td>(hr, min, sec)</td>
</tr>
<tr>
<td></td>
<td>-or-</td>
<td>(set in endpoint panel)</td>
</tr>
<tr>
<td></td>
<td>• Endpoint Detector</td>
<td></td>
</tr>
<tr>
<td>Throttle Control</td>
<td>• Pressure</td>
<td>Setpoint (mTorr)</td>
</tr>
<tr>
<td></td>
<td>-or-</td>
<td>Setpoint (%)</td>
</tr>
<tr>
<td></td>
<td>• Position (Relative)</td>
<td></td>
</tr>
<tr>
<td>Gas</td>
<td>Channel Name</td>
<td>Setpoint (sccm)</td>
</tr>
<tr>
<td>Backside Cooling</td>
<td>He (flow)</td>
<td>Setpoint (sccm)</td>
</tr>
<tr>
<td>ICP RF</td>
<td>Power *</td>
<td>Setpoint (Watts)</td>
</tr>
<tr>
<td>Bias RF</td>
<td>Power</td>
<td>Setpoint (Watts)</td>
</tr>
<tr>
<td></td>
<td>AMN Mode</td>
<td>(Auto, Man/Auto, or Manual)</td>
</tr>
<tr>
<td></td>
<td>Load*</td>
<td>Setpoint (%)</td>
</tr>
<tr>
<td></td>
<td>Tune*</td>
<td>Setpoint (%)</td>
</tr>
</tbody>
</table>
XFER Settings

(None)

EVAC

<table>
<thead>
<tr>
<th>Panel</th>
<th>Parameter</th>
<th>Settings</th>
</tr>
</thead>
<tbody>
<tr>
<td>Pumping</td>
<td>Base Pressure Hold Time</td>
<td>Vacuum Setpoint (in Torr)</td>
</tr>
<tr>
<td></td>
<td></td>
<td>(hours, minutes, seconds)</td>
</tr>
</tbody>
</table>

END Settings

<table>
<thead>
<tr>
<th>Panel</th>
<th>Parameter</th>
<th>Settings</th>
</tr>
</thead>
<tbody>
<tr>
<td>Pumping</td>
<td>Base Pressure Hold Time</td>
<td>Setpoint (Torr)</td>
</tr>
<tr>
<td></td>
<td>Hold Time (step time)</td>
<td>(hours, minutes, seconds)</td>
</tr>
<tr>
<td>Material Handling</td>
<td>Transfer Material Out</td>
<td>• Enabled</td>
</tr>
<tr>
<td></td>
<td></td>
<td>• Disabled</td>
</tr>
<tr>
<td></td>
<td>Vent Lock</td>
<td>• Enabled</td>
</tr>
<tr>
<td></td>
<td></td>
<td>• Disabled</td>
</tr>
</tbody>
</table>
Editing a Process Recipe

Proceed as follows to edit a process recipe in the <<Recipe Editor>> list.

1. Select the recipe being edited from the <<Stored Recipes>> list.
   a. The <<Step Name>> field should display the selected step’s name.
   b. If the recipe is being saved as a new recipe, change the recipe name here.
2. Edit the selected recipe by inserting, copying, or deleting steps in the <<Recipe Steps>> list.
3. Set up the parameters in the step panel for each step. Apply ramping, compliance, and endpoint detection parameters if necessary.

Deleting a Process Recipe

Proceed as follows to delete a process recipe in the <<Recipe Editor>> screen:

1. Select the recipe being deleted from the <<Stored Recipes>> list.
2. Click on the [Delete] button to remove the recipe from the system.
3. The system will ask for confirmation. Select [yes] to delete.
   a. The recipe should now be removed from the <<Stored Recipes>> list.